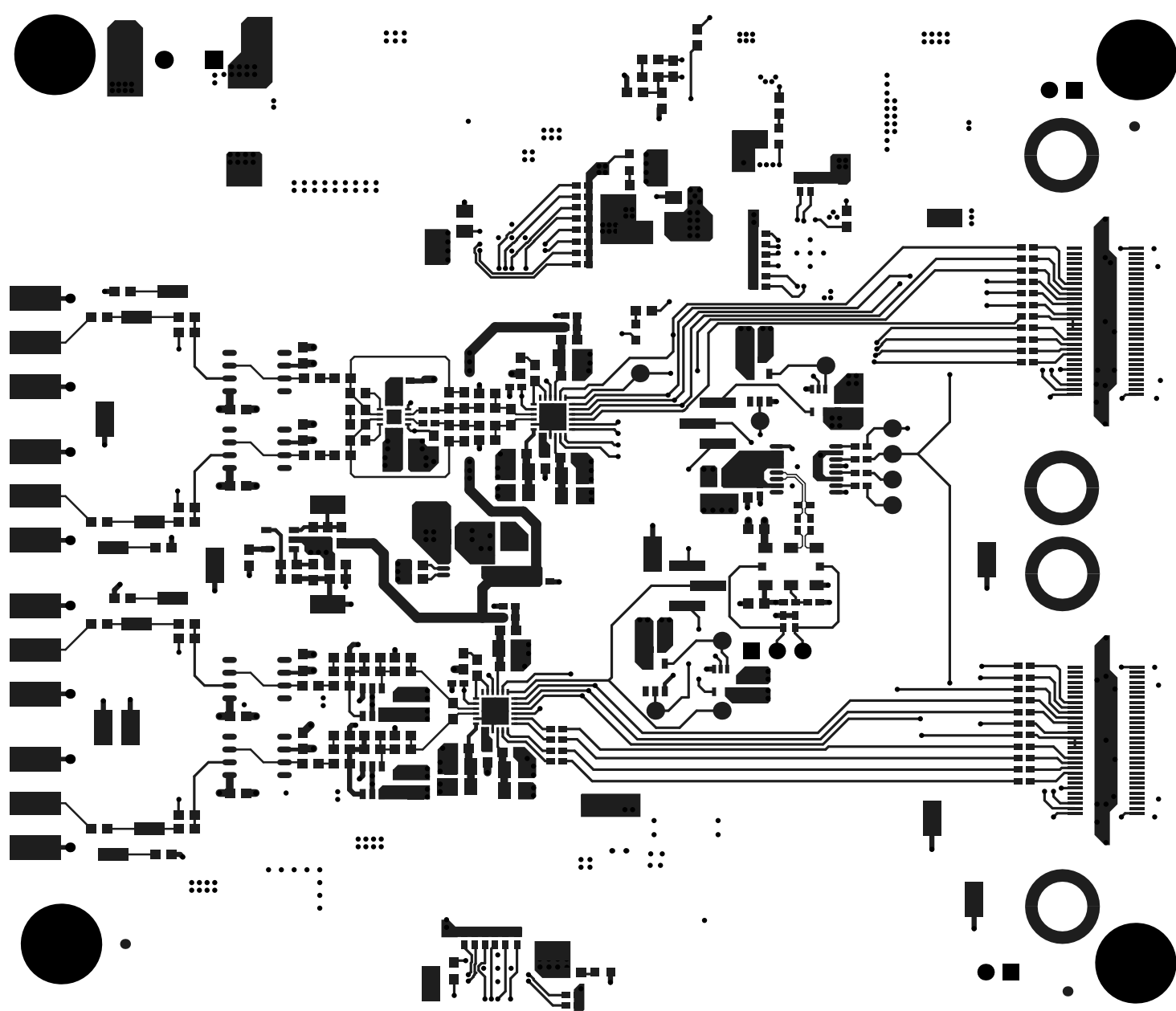
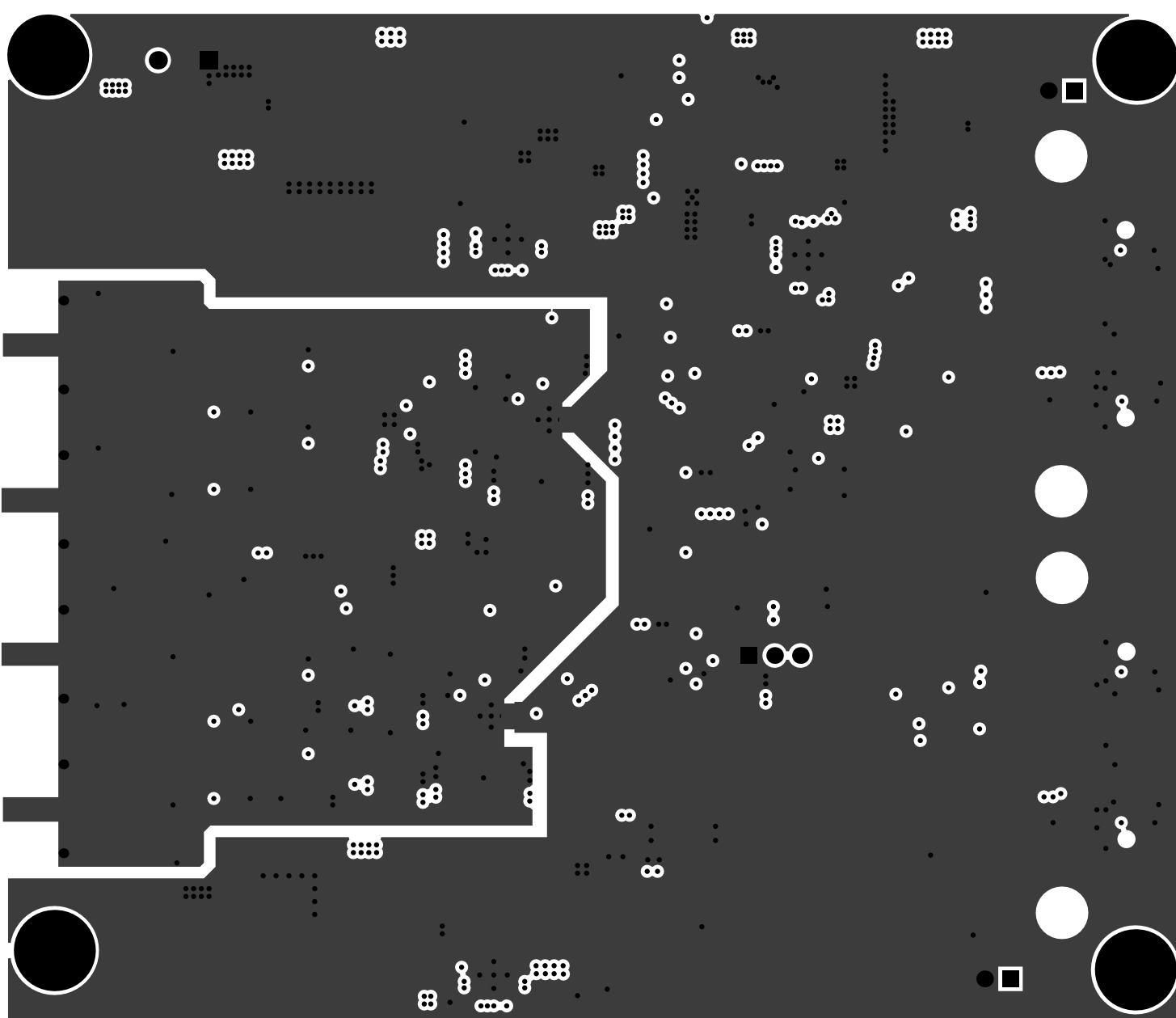


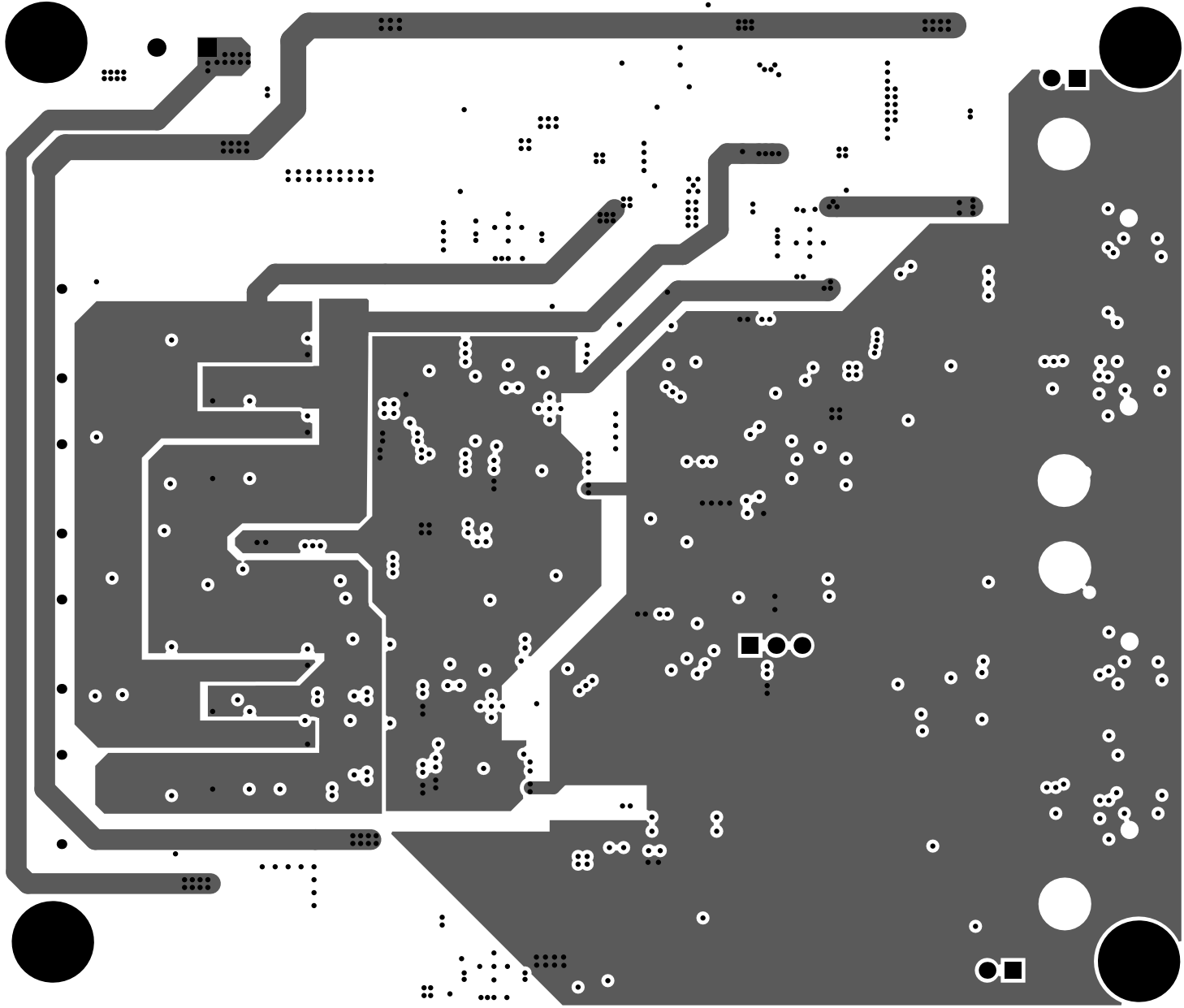
Top Overlay

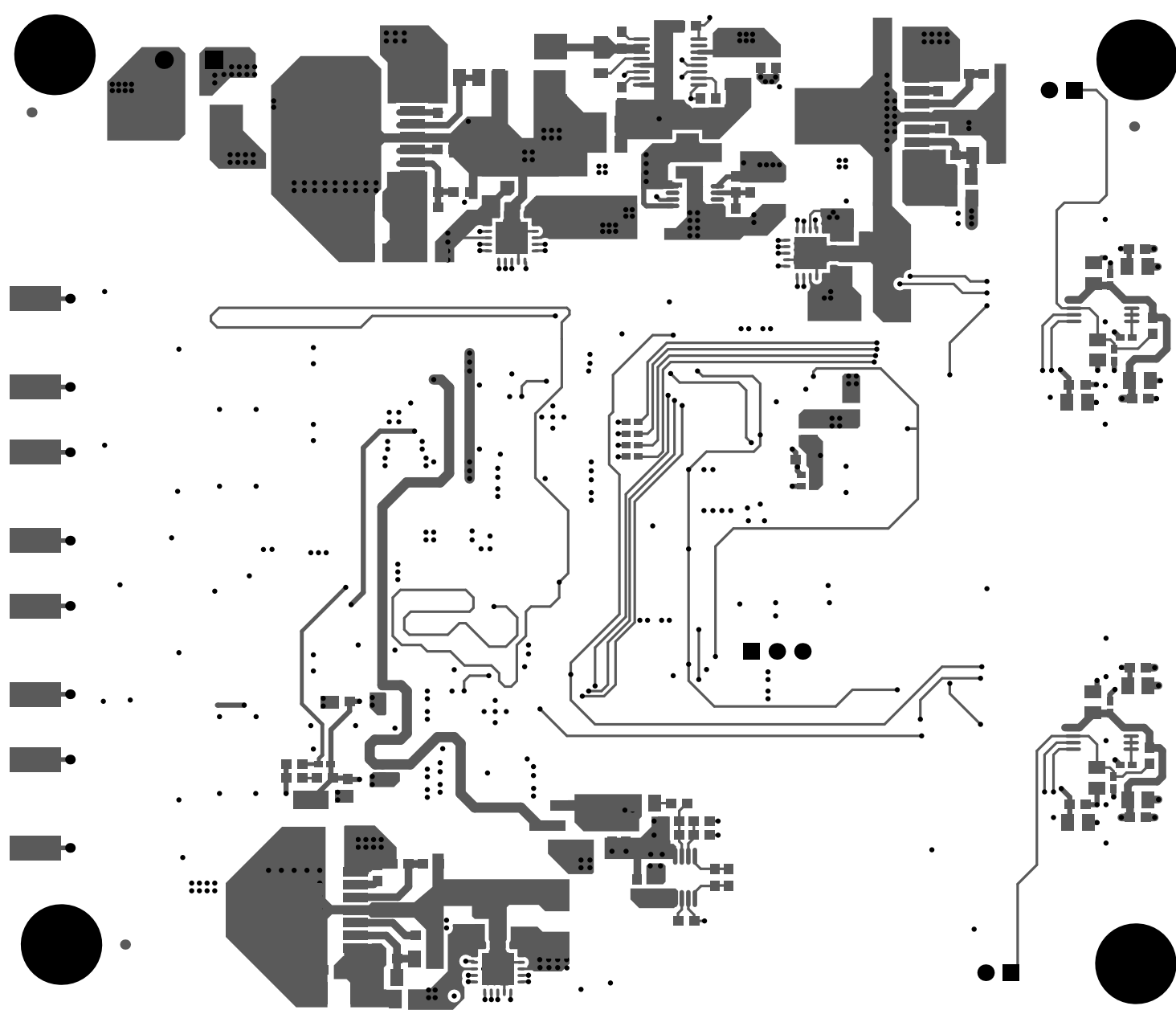


Layer 1 - Top Layer

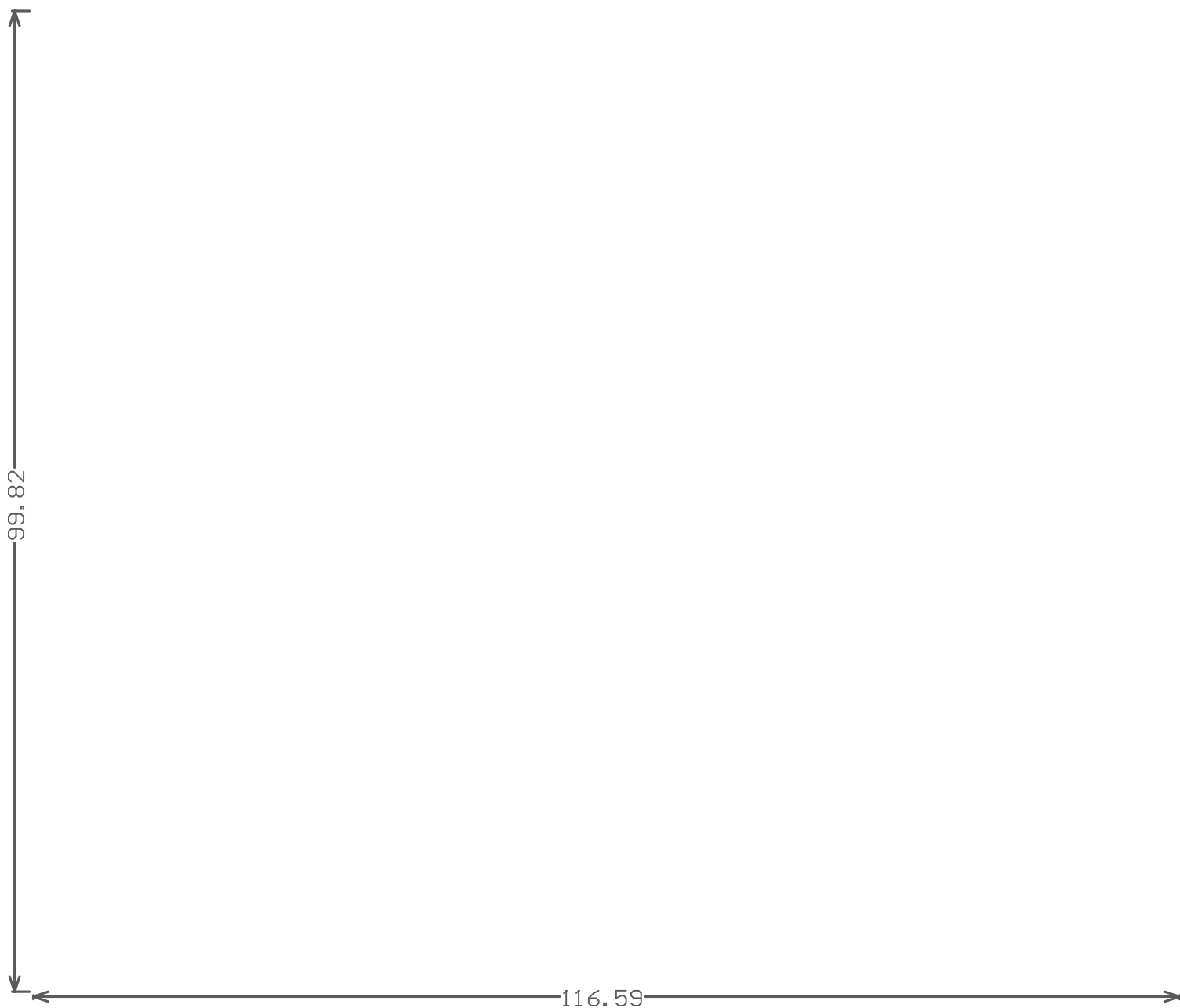


Layer 2 - GND





Layer 4 - Bottom Layer



M2 Board Dimensions

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